



ULIS ramps up production of 12-micron thermal sensor, on exhibit at SPIE DCS in Orlando

News Update – At SPIE Defense and Commercial Sensing in Orlando, (April 15 – 19), ULIS will be exhibiting its latest 12-micron thermal image sensor, [Atto320](#), currently in production ramp up for availability in mass volumes by end 2018.

A camera demo of the Atto320, a QVGA sensor for industrial, surveillance, leisure and outdoor applications, will be on display at booth #806.

ULIS' proficiency with 12 μ m technologies is enabling it to extend the product offering to a new VGA format, the Atto640. Atto640 VGA will be available for sampling at year-end. Both Atto320 and Atto640 are pin-to-pin compatible facilitating 'drop-in' replacement. They share the same footprint (16.5mmx16.5mmx3.4mm) and are both fully digital.

ULIS invites you to join them at SPIE DCS to discover how it responds to needs in applications requiring compactness and low power consumption (SWaP-C). Our team will also be available to discuss the performance of our fast bolometers (Thermal Time Constant <2.5ms) ideal for high-speed applications, such as machine vision or missile warning systems.

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